

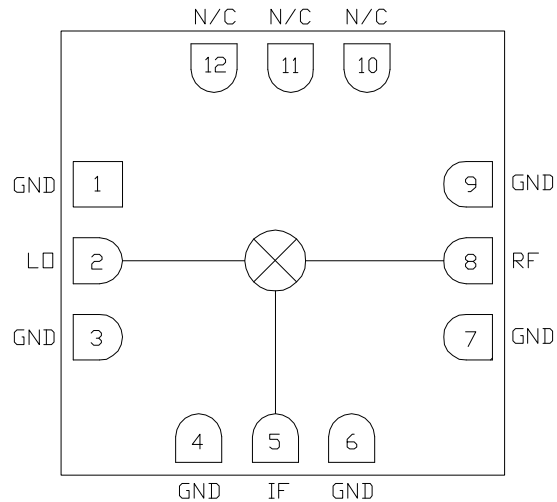
Features

- ▶ Low conversion loss
- ▶ High isolation
- ▶ Wide IF bandwidth
- ▶ Passive double balanced topology
- ▶ Pb-free RoHs compliant 3x3 mm SMT package

Description

The CMD180C3 is a general purpose double balanced mixer in a leadless surface mount package that can be used for up- and downconverting applications between 20 and 32 GHz. The CMD180C3 has very high isolation to both the RF and IF ports due to the optimized balun structures, and can operate with an LO drive level as low as +9 dBm. The CMD180C3 can easily be configured as an image reject mixer or single sideband modulator with external hybrids and power splitters.

Functional Block Diagram



Electrical Performance - IF = 100 MHz, LO = +13 dBm, $T_A = 25^\circ\text{C}$, F = 26 GHz

Parameter	Min	Typ	Max	Units
Frequency Range, RF & LO	20 - 32			GHz
Frequency Range, IF	DC		10	GHz
Conversion Loss		7		dB
LO to RF Isolation		36		dB
LO to IF Isolation		36		dB
RF to IF Isolation		26		dB
Input P1dB		10		dBm

Unless otherwise noted, all measurements performed as a downconverter, IF = 100 MHz



CMD180C3

20-32 GHz Fundamental Mixer

Specifications

Absolute Maximum Ratings

Parameter	Rating
RF / IF Input Power	+25 dBm
LO Drive	+25 dBm
Operating Temperature	-40 to 85 °C
Storage Temperature	-55 to 150 °C

Operation of this device outside the maximum ratings may cause permanent damage.

Electrical Specifications - IF = 100 MHz, LO = +13 dBm, T_A = 25 °C

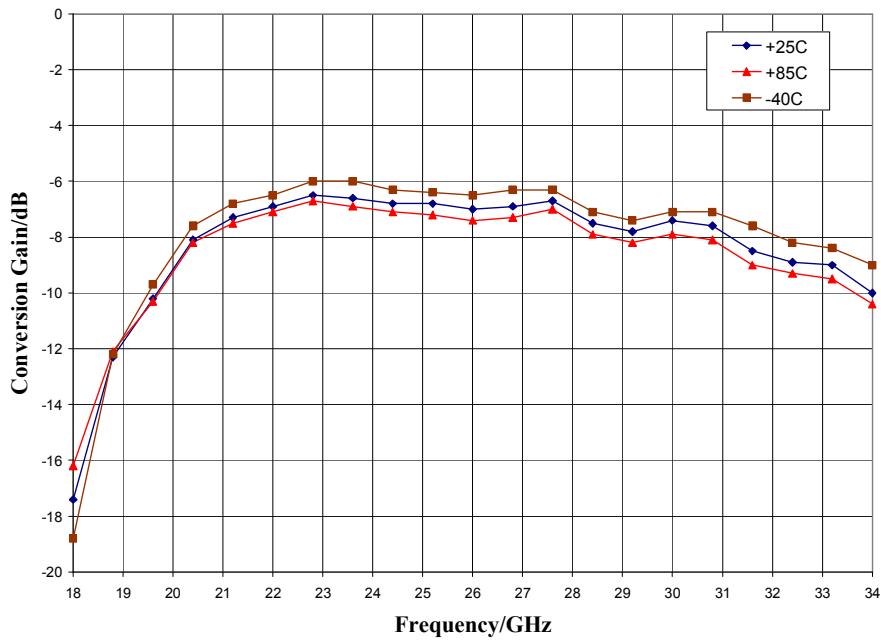
Parameter	Min	Typ	Max	Min	Typ	Max	Units
Frequency Range, RF & LO	22 - 28			20 - 32			GHz
Frequency Range, IF	DC		10	DC		10	GHz
Conversion Loss		7	9		7	11	dB
Noise Figure (SSB)		7	9		7	11	dB
LO to RF Isolation	31	36		27	36		dB
LO to IF Isolation	30	38		27	38		dB
RF to IF Isolation	19	26		16	26		dB
Input P1dB		10			9		dBm
Input IP3		18			18		dBm

Unless otherwise noted, all measurements performed as a downconverter, IF = 100 MHz

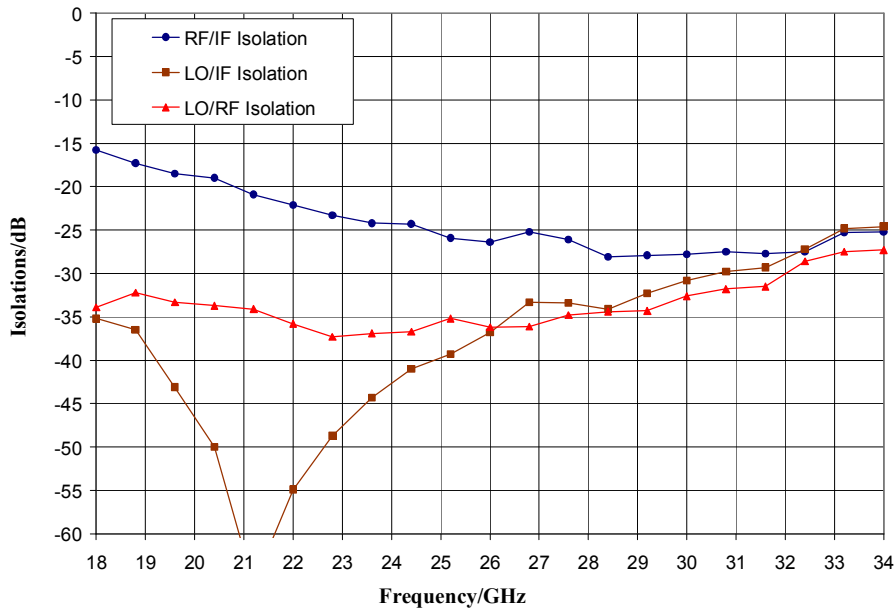
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Typical Performance

Conversion Gain vs. Temperature, LO = +13 dBm, IF = 100 MHz USB

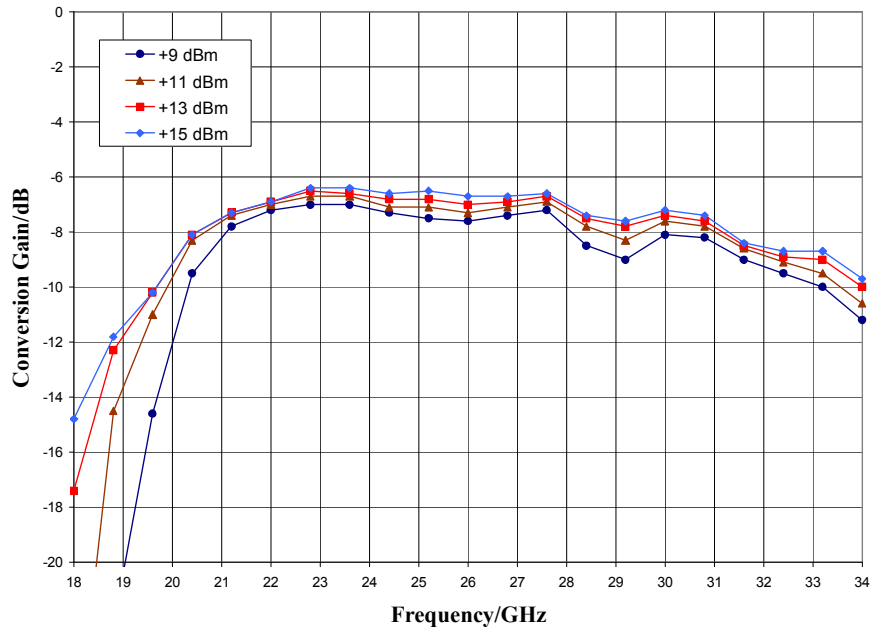


Isolation, LO = +13 dBm

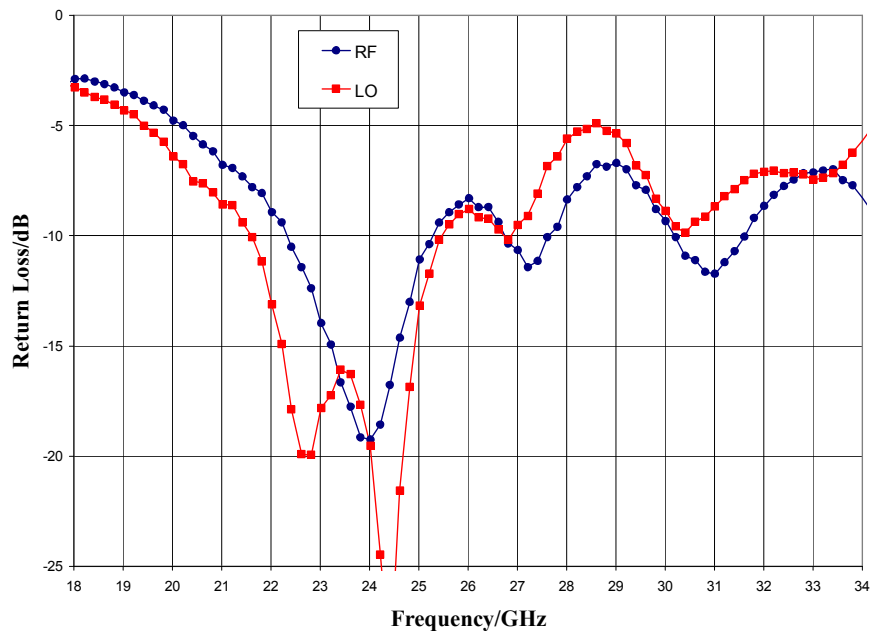


Typical Performance

Conversion Gain vs. LO Drive, IF = 100 MHz USB



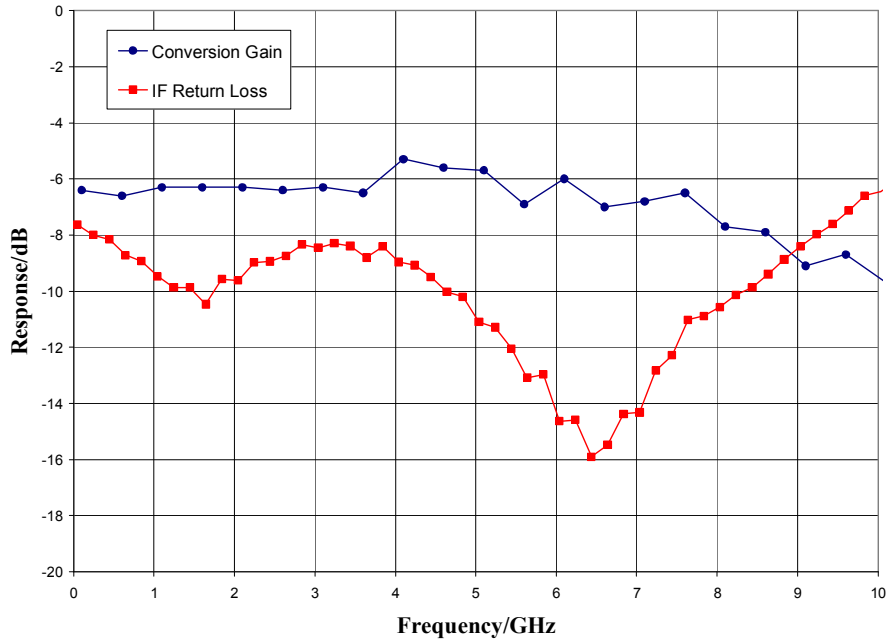
Return Loss, LO = + 13 dBm



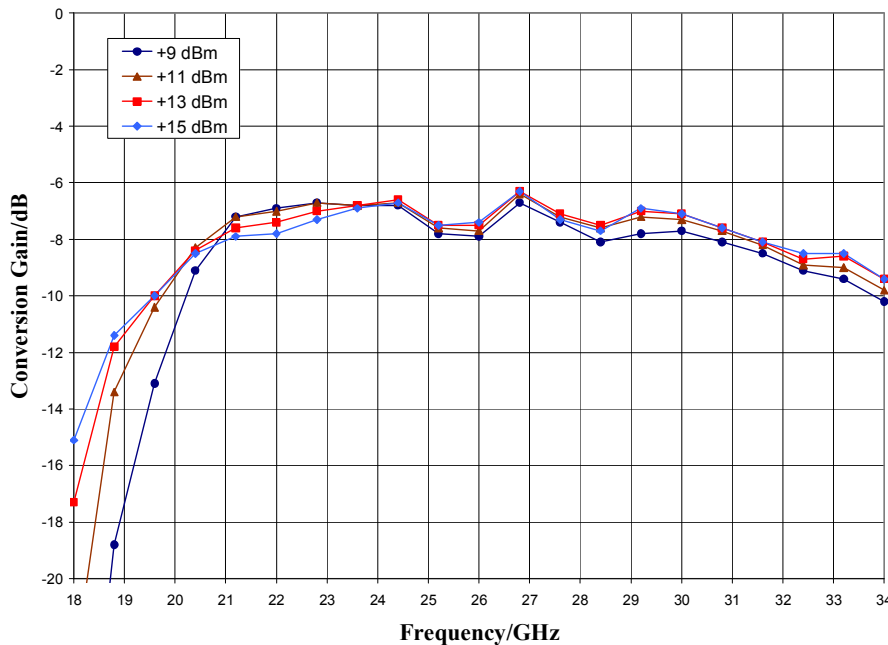
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Typical Performance

IF Bandwidth, LO = +13 dBm



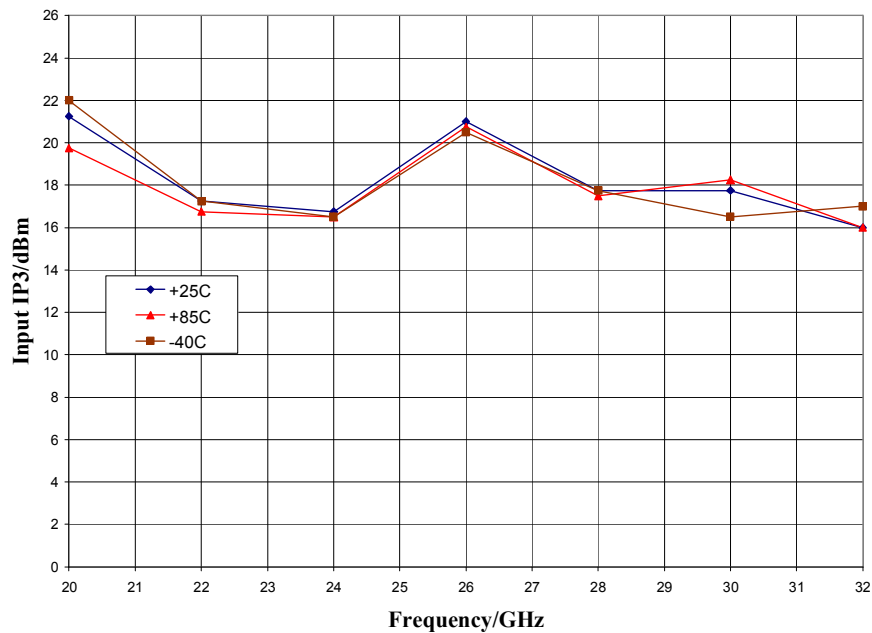
Upconverter Performance, Conversion Gain vs. LO Drive, IF input = 100 MHz



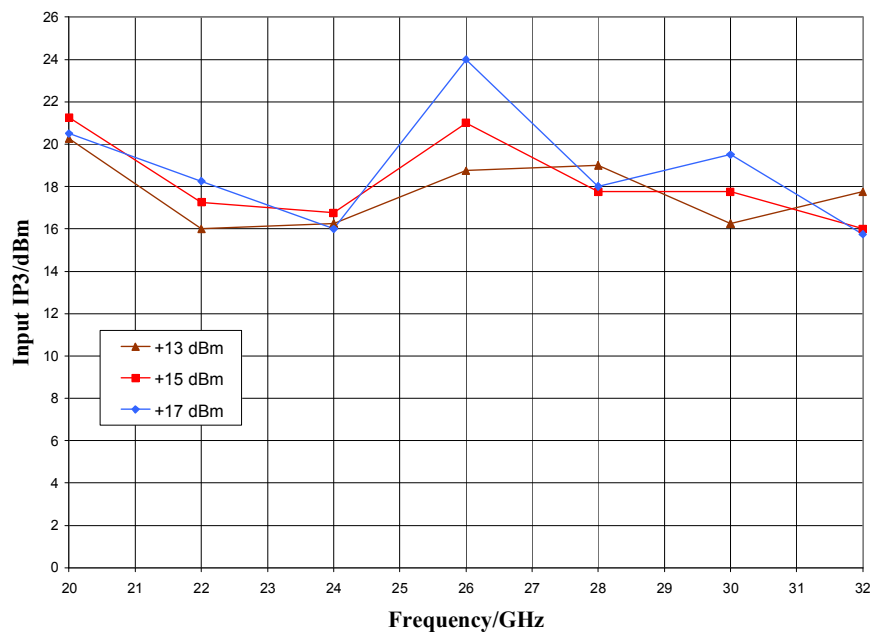
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Typical Performance

Input IP3 vs. Temperature, LO = +15 dBm, IF = 100 MHz



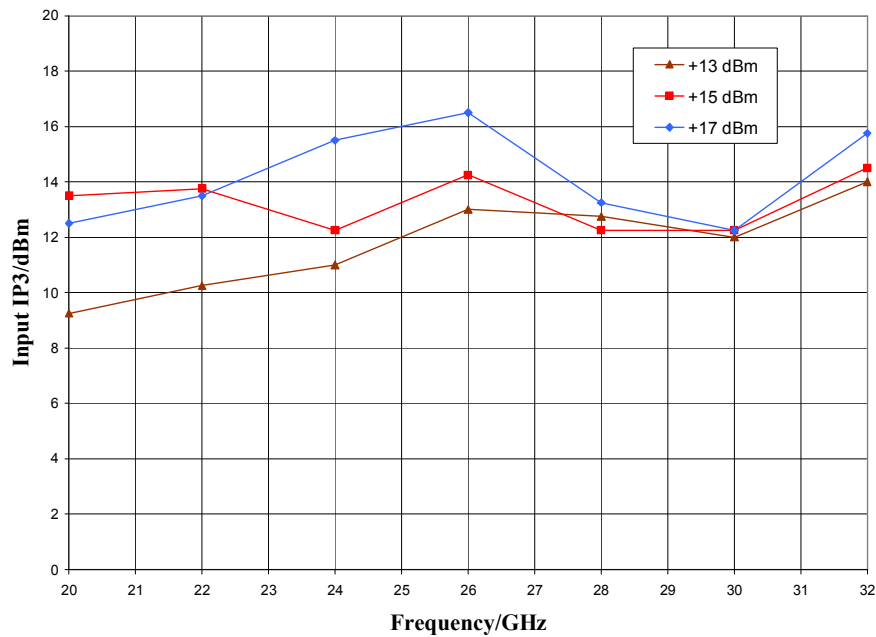
Input IP3 vs. LO Drive, IF = 100 MHz



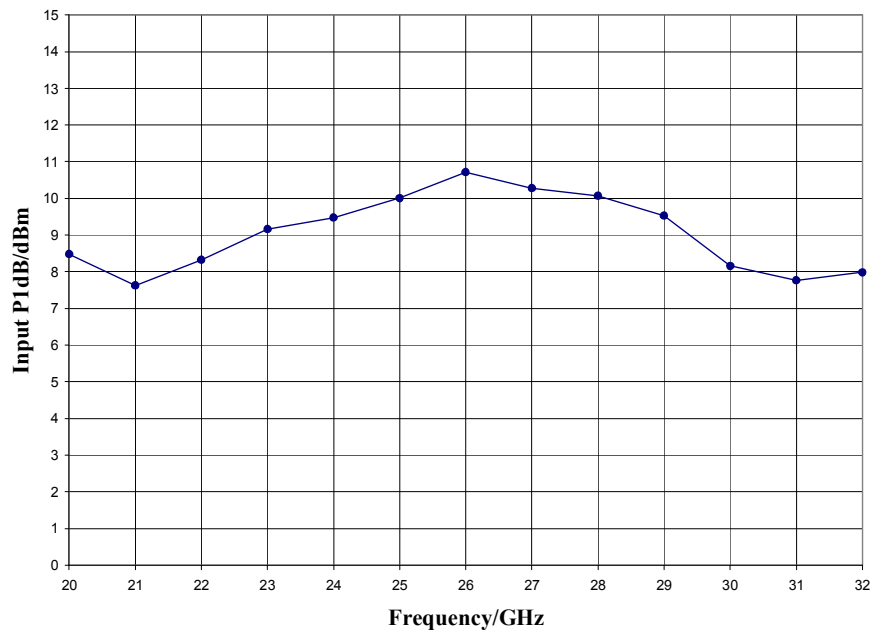
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Typical Performance

Upconverter Performance, Input IP3 vs. LO Drive, IF = 100 MHz



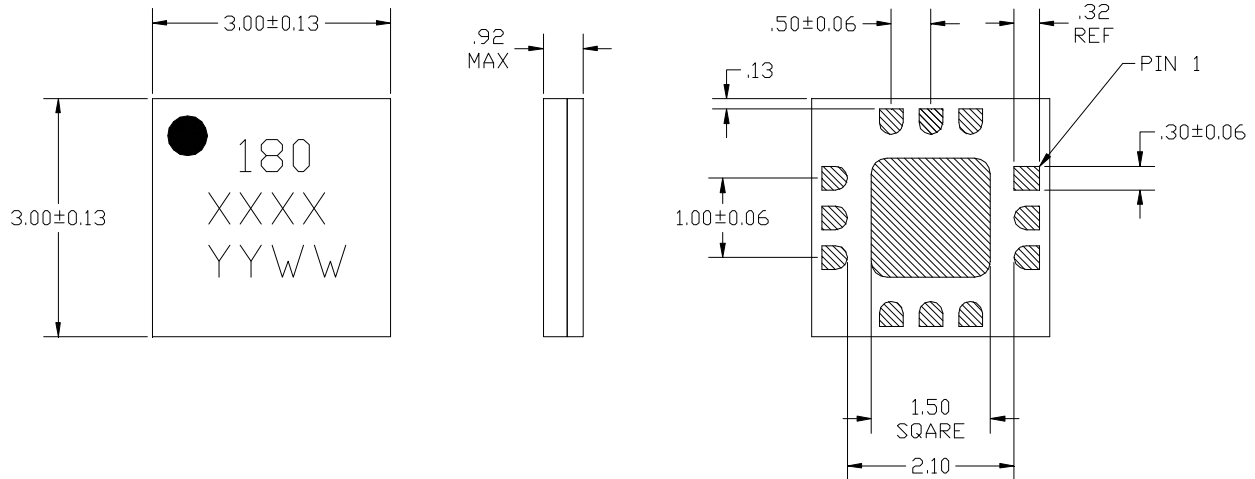
Input P1dB, LO = +13 dBm, IF = 100 MHz USB



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Mechanical Information

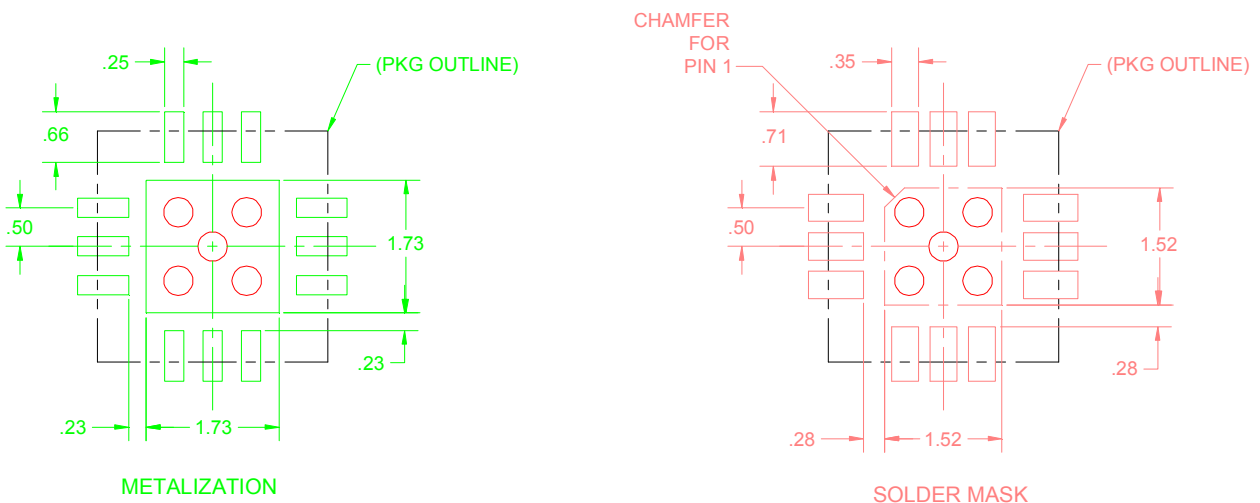
Package Information and Dimensions



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS
2. MATERIAL: BLACK ALUMINA
3. LEAD FINISH: 30-80 MICRONS GOLD OVER 50 MICRONS NICKEL.
4. ALTERNATE PIN #1 IDENTIFIER IS SINGLE SQUARE PAD.

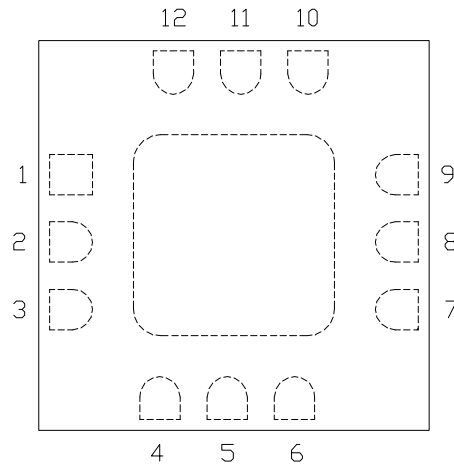
Recommended PCB Land Pattern




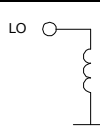
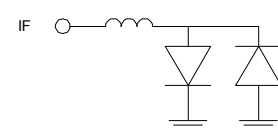
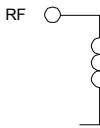
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Pin Description

Pin Diagram



Functional Description

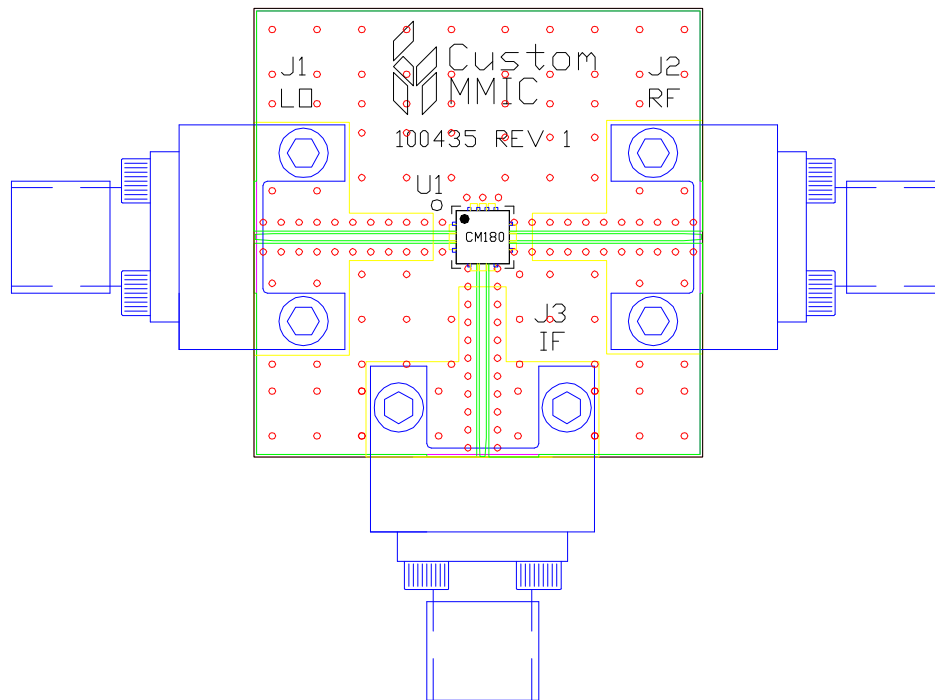
Pin	Function	Description	Schematic
1,3,4,6,7,9 and die paddle	Ground	Connect to RF / DC ground.	
2	LO	This pin is DC coupled and matched to 50 ohms.	
5	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source or sink more than 16 mA of current or part non-function or part failure may result.	
8	RF	This pin is DC coupled and matched to 50 ohms.	
10-12	N/C	No connection required. These pins may be connected to RF/DC ground	

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Applications Information

Evaluation Board

The circuit board shown has been developed for optimized assembly at Custom MMIC. A sufficient number of via holes should be used to connect the top and bottom ground planes. As surface mount processes vary, careful process development is recommended.



Bill of Material

Designator	Value	Description
J1 - J3		SMA End Launch Connector
U1		CMD180C3 Fundamental Mixer
PCB		100435 Evaluation PCB

GaAs MMIC devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.

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